

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
CHENGWEN QUE	07/14/2011
YU-CHUN HSIAO	07/07/2011
RECEIVING PARTY DATA	
Name:	SHENZHEN CHINA STAR OPTOELECTRONICS TECHNOLOGY CO., LTD.
Street Address:	NO. 9-2 TANGMING ROAD, GUANGMING NEW DISTRICT, BAO'AN DISTRICT
City:	SHENZHEN CITY, GUANGDONG
State/Country:	CHINA
Postal Code:	518132
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13318148
CORRESPONDENCE DATA	
Fax Number:	(000)000-0000
Phone:	714-390-9373
Email:	evonscj@gmail.com
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>	
Correspondent Name:	CHENG-JU CHIANG
Address Line 1:	P.O. Box 766
Address Line 4:	Chino, CALIFORNIA 91708
ATTORNEY DOCKET NUMBER:	WISPRO-SZ-00044
NAME OF SUBMITTER:	CHENG-JU CHIANG
Total Attachments: 2 source=WISPRO-SZ-00044-Assignment#page1.tif source=WISPRO-SZ-00044-Assignment#page2.tif	

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REEL: 027144 FRAME: 0441

ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, the following inventor(s) (hereinafter as "ASSIGNOR")

1. Name QUE, Chengwen
Residing at NO.9-2, Tangming Rd, Guangming New district, Bao'an District, Shenzhen City, Guangdong, China
2. Name HSIAO, Yu-chun
Residing at NO.9-2, Tangming Rd, Guangming New district, Bao'an District, Shenzhen City, Guangdong, China

hereby sells, assign, transfers, and sets over to Shenzhen China Star Optoelectronics Technology Co., Ltd. of NO.9-2, Tangming Rd, Guangming New district, Bao'an District, Shenzhen City, Guangdong, China (hereinafter as "ASSIGNEE"), its successors and assigns, the entire right, title and interest in and to the invention known as LCD DEVICE AND BACK COVER THEREOF (hereinafter as "INVENTION"), for which a United States Patent Application was executed concurrently herewith or, if not so executed, was:

- a. executed on _____;
- b. filed on _____, Application Serial No. _____; or
- c. established by PCT International Patent Application No. PCT/CN2011/075467.

and all rights and privileges under any Letters Patent which may be granted thereon, including all rights, if any, to sue for past infringement.

The ASSIGNOR hereby agrees without charge to said ASSIGNEE but at its expense to execute all necessary papers to be used in connection with the above-identified application and any additional, substitute, continuing, divisional, reexamination, or reissue applications, as the ASSIGNEE may deem necessary or expedient; to execute all papers in connection with any interference or other legal or quasi-legal proceedings relating to the above-identified application or any additional, substitute, continuing, divisional, reexamination, reissue applications thereof; to cooperate with the ASSIGNEE in every way possible in obtaining evidence and going forward in any such proceedings; and to perform all other affirmative acts which may be necessary or desirable to obtain a grant of a valid patent for said INVENTION.

The ASSIGNOR hereby agrees to communicate to the ASSIGNEE, or its representatives, any facts known to the ASSIGNOR respecting said INVENTION, and testify in any legal proceedings, sign all lawful papers, execute all necessary assignment papers to cause any and all Letters Patent to be issued to the ASSIGNEE, make all rightful oaths and generally do everything necessary or desirable to aid the ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said INVENTION.

ASSIGNMENT (CONTINUED)

The ASSIGNOR hereby authorizes and requests the Commissioner of the United States Patent and Trademark Office to issue any and all Letters Patent that may be granted upon any patent application for the INVENTION or any additional, substitute, continuing, or divisional applications thereof to the ASSIGNEE, its successors and assigns.

The ASSIGNOR hereby covenants and warrants that the ASSIGNOR has full right to convey the entire right, title and interest in and to said INVENTION by this assignment, free of any encumbrances and that no other agreement has been or will be executed in conflict herewith.

Signature of
Inventor 1

QUE, Chengwen
QUE, Chengwen

Executed Date

2011.7.14

Signature of
Inventor 2

HSIAO, Yu-Chun
HSIAO, Yu-chun

Executed Date

7th Jul 2011